

# Stellaris<sup>®</sup> LM3S1627 RevA0 Errata

This document contains known errata at the time of publication for the Stellaris LM3S1627 microcontroller. The table below summarizes the errata and lists the affected revisions. See the data sheet for more details.

See also the ARM® Cortex<sup>™</sup>-M3 errata, ARM publication number PR326-PRDC-009450 v2.0.

#### Table 1. Revision History

Date	Revision	Description
September 2011	2.8	Added issue "Boundary scan is not functional" on page 4.
August 2011	2.7	<ul> <li>Clarified issue "General-purpose timer 16-bit Edge Count or Edge Time mode does not load reload value" on page 10 to include Edge-Time mode.</li> </ul>
		<ul> <li>Added issue "Retriggering a sample sequencer before it has completed the current sequence results in continuous sampling" on page 13.</li> </ul>
		Added issue "ADC inputs have the incorrect channel assignments" on page 14.
		<ul> <li>Added issue "PWM fault latch does not operate correctly" on page 17.</li> </ul>
		<ul> <li>Minor edits and clarifications.</li> </ul>
September 2010	2.6	Added issue "MOSC valid detect circuit should not be enabled" on page 5.
		<ul> <li>Removed the "ROM_I2CMasterErr function is incorrect" issue because the data sheet has been changed such that the ERROR bit no longer is set when the ARBLST bit is set.</li> </ul>
		<ul> <li>Minor edits and clarifications.</li> </ul>
July 2010	2.5	<ul> <li>Added information that "No interrupt generated with software-triggered DMA transfer using channel 30" on page 6 is fixed for parts with certain date codes.</li> </ul>
		Added issue "PB0 and PB1 have permanent internal pull-down resistance" on page 8.
		<ul> <li>Added issue "The RTRIS bit in the UARTRIS register is only set when the interrupt is enabled" on page 14.</li> </ul>
		<ul> <li>Minor edits and clarifications.</li> </ul>
June 2010	2.4	<ul> <li>Added issue "External reset does not reset the XTAL to PLL Translation (PLLCFG) register" on page 5.</li> </ul>
May 2010	2.3	<ul> <li>Minor edits and clarifications.</li> </ul>
April 2010	2.2	<ul> <li>Minor edits and clarifications.</li> </ul>
April 2010	2.1	<ul> <li>Removed issue "Setting Bit 7 in I2C Master Timer Period (I2CMTPR) register may have unexpected results". The data sheet description has changed such that this is no longer necessary.</li> </ul>
		<ul> <li>Minor edits and clarifications.</li> </ul>
February 2010	2.0	<ul> <li>Added issue "The General-Purpose Timer match register does not function correctly in 32-bit mode" on page 11.</li> </ul>
		<ul> <li>Added issue "Setting Bit 7 in I2C Master Timer Period (I2CMTPR) register may have unexpected results".</li> </ul>

Date	Revision	Description	
Jan 2010	1.9	<ul> <li>"Hard Fault possible when waking from Sleep or Deep-Sleep modes and Cortex-M3 Debug Access Port (DAP) is enabled" has been removed and the content added to the LM3S1627 data sheet.</li> </ul>	
		<ul> <li>Added issue "The µDMA controller fails to generate capture mode DMA requests from Timer A in the Timer modules" on page 7.</li> </ul>	
		<ul> <li>Added issue "A spurious DMA request is generated when the timer rolls over in Input-Edge Time mode" on page 11.</li> </ul>	
Dec 2009	1.8	Started tracking revision history.	

#### Table 2. List of Errata

Number	Erratum Title	Module Affected	Revision(s) Affected
1.1	Subsequent attempts to mass erase the Flash memory following a locked device recovery will fail	JTAG and Serial Wire Debug	A0
1.2	JTAG INTEST instruction does not work	JTAG and Serial Wire Debug	A0
1.3	Boundary scan is not functional	JTAG and Serial Wire Debug	A0
2.1	Debugger cannot halt processor when in Sleep mode	System Control	A0
2.2	I/O buffer 5-V tolerance issue	System Control	A0
2.3	External reset does not reset the XTAL to PLL Translation (PLLCFG) register	System Control	A0
2.4	MOSC valid detect circuit should not be enabled	System Control	A0
3.1	FMPPE and FMPRE registers cannot be committed to non-volatile storage	Flash Controller	A0
4.1	ROM_SSIConfigSetExpClk function is incorrect	ROM	A0
5.1	No interrupt generated with software-triggered DMA transfer using channel 30	μDMA	A0
5.2	The $\mu\text{DMA}$ controller fails to generate capture mode DMA requests from Timer A in the Timer modules	μDMA	A0
6.1	GPIO commit register control not working as expected	GPIO	A0
6.2	PB0 and PB1 have permanent internal pull-down resistance	GPIO	A0
7.1	General-purpose timer 16-bit Edge Count or Edge Time mode does not load reload value	General-Purpose Timers	A0
7.2	The General-Purpose Timer match register does not function correctly in 32-bit mode	General-Purpose Timers	A0
7.3	A spurious DMA request is generated when the timer rolls over in Input-Edge Time mode	General-Purpose Timers	A0
8.1	Use of "Always" triggering for ADC Sample Sequencer 3 does not work	ADC	A0
8.2	Using the PWM unit to trigger the ADC results in only one sample taken	ADC	A0
8.3	TIMER3 cannot trigger ADC	ADC	A0

Erratum Number	Erratum Title	Module Affected	Revision(s) Affected
8.4	Incorrect behavior with timer ADC triggering when another timer is used in 32-bit mode	ADC	A0
8.5	ADC hardware averaging produces erroneous results in differential mode	ADC	A0
8.6	Retriggering a sample sequencer before it has completed the current sequence results in continuous sampling	ADC	A0
8.7	ADC inputs have the incorrect channel assignments	ADC	A0
9.1	The RTRIS bit in the UARTRIS register is only set when the interrupt is enabled	UART	A0
10.1	I <sup>2</sup> C Slave Masked Interrupt Status (I2CSMIS) register bits are incorrect	I2C	A0
11.1	PWM generation is incorrect with extreme duty cycles	PWM	A0
11.2	PWM sync status is not properly cleared	PWM	A0
11.3	Sync of PWM does not trigger "zero" action	PWM	A0
11.4	PWM "zero" action occurs when the PWM module is disabled	PWM	A0
11.5	PWM fault latch does not operate correctly	PWM	A0
12.1	QEI index resets position when index is disabled	QEI	A0
12.2	QEI hardware position can be wrong under certain conditions	QEI	A0
13.1	Certain pins do not fully comply with the JEDEC ESD standard	Electrical Characteristics	A0

# 1 JTAG and Serial Wire Debug

## 1.1 Subsequent attempts to mass erase the Flash memory following a locked device recovery will fail

#### Description:

If a user performs a locked device recovery as described in the data sheet, subsequent attempts to mass erase the Flash memory will fail. The failure status in the **Flash Controller Raw Interrupt Status (FCRIS)** register following the attempted mass erase operation has the Access Raw Interrupt Status (ARIS) bit set, indicating an access error. The access error is generated because the recovery sequence incorrectly restores **Flash Memory Protection Enable 2 (FMPPE2)** and **FMPPE3** to the value 0xFFFF.FFFF. During subsequent mass erase attempts, the logic (that ensures write-protected Flash memory is not erased) incorrectly evaluates the protected condition and inhibits the erase operation.

**Note:** This erratum may affect the ROM-resident boot loader because this module utilizes Flash memory mass erase. The boot loader will not function following a recovery sequence because the boot loader attempts a mass erase, detects the error code, and terminates.

#### Workaround:

There is a dynamic workaround in which the **FMPPEn** registers are written to properly set the **FMPPEn** state before a mass erase is attempted. The **FMPPEn** registers must be written to the values indicated in the following table based on the size of Flash memory available on the

microcontroller. The **FMPPEn** register must be written before each mass erase operation that is attempted.

Flash Size (KB)	FMPPE3	FMPPE2	FMPPE1	FMPPE0
128	0x0000.0000	0x0000.0000	0xffff.ffff	0xffff.ffff
96	0x0000.0000	0x0000.0000	0x0000.ffff	0xffff.fff
64	0x0000.0000	0x0000.0000	0x0000.0000	0xffff.ffff
32	0x0000.0000	0x0000.0000	0x0000.0000	0x0000.ffff

#### Table 3. FMPPEn Default Values Based on Flash Memory Size

#### Silicon Revision Affected:

A0

### **1.2 JTAG INTEST instruction does not work**

#### **Description:**

The JTAG INTEST (Boundary Scan) instruction does not properly capture data.

Workaround:

None.

Silicon Revision Affected:

A0

### **1.3 Boundary scan is not functional**

#### **Description:**

The boundary scan is not functional on this device.

#### Workaround:

None.

#### Silicon Revision Affected:

A0

Fixed:

Fixed on devices with date codes of 0x1A (October, 2011) or later.

## 2 System Control

## 2.1 Debugger cannot halt processor when in Sleep mode

#### **Description:**

When the processor is in Sleep mode, the debugger is unable to bring the processor out of Sleep mode in order to initiate a debug session.

#### Workaround:

Do not use Sleep mode when attempting to debug the application.

Silicon Revision Affected:

A0

### 2.2 I/O buffer 5-V tolerance issue

#### **Description:**

GPIO buffers are not 5-V tolerant when used in open-drain mode. Pulling up the open-drain pin above 4 V results in high current draw.

#### Workaround:

When configuring a pin as open drain, limit any pull-up resistor connections to the 3.3-V power rail.

#### Silicon Revision Affected:

A0

# 2.3 External reset does not reset the XTAL to PLL Translation (PLLCFG) register

#### **Description:**

Performing an external reset (anything but power-on reset) reconfigures the XTAL field in the **Run-Mode Clock Configuration (RCC)** register to the 6 MHz setting, but does not reset the **XTAL** to **PLL Translation (PLLCFG)** register to the 6 MHz setting.

Consider the following sequence:

- 1. Performing a power-on reset results in XTAL = 6 MHz and PLLCFG = 6 MHz
- 2. Write an 8 MHz value to the XTAL field results in XTAL = 8 MHz and PLLCFG = 8 MHz
- **3.** RST asserted results in XTAL = 6 MHz and **PLLCFG** = 8 MHz

In the last step, **PLLCFG** was not reset to its 6MHz setting. If this step is followed by enabling the PLL to run from an attached 6-MHz crystal, the PLL then operates at 300MHz instead of 400MHz. Subsequently configuring the XTAL field with the 8 MHz setting does not change the setting of **PLLCFG**.

#### Workaround:

Set XTAL in **PLLCFG** to an incorrect value, and then to the desired value. The second change updates the register correctly. Do not enable the PLL until after the second change.

#### Silicon Revision Affected:

A0

### 2.4 MOSC valid detect circuit should not be enabled

#### **Description:**

If bit 0 of the **Main Oscillator Control (MOSCCTL)** register is set, the microcontroller is immediately reset and control is transferred to the NMI handler, even if the MOSC is functioning correctly.

#### Workaround:

None.

Silicon Revision Affected:

A0

# 3 Flash Controller

# 3.1 FMPPE and FMPRE registers cannot be committed to non-volatile storage

#### **Description:**

The Flash memory protection provided by the **Flash Memory Protection Read Enable n (FMPREn)** and **Flash Memory Protection Program Enable n (FMPPEn)** registers does not function correctly. Do not commit any of these registers or mass erase will not function.

This does not affect the Flash memory protection provided by the disabling of the JTAG/SWD port.

#### Workaround:

None.

Silicon Revision Affected:

A0

## 4 ROM

## 4.1 ROM\_SSIConfigSetExpClk function is incorrect

#### **Description:**

If a non-Motorola format was specified in a call to the ROM\_SSIConfigSetExpClk function, two lower bits of a clock divisor register could be corrupted. This corruption results in a small error in the actual clock rate.

#### Workaround:

Use the StellarisWare SSIConfigSetExpClk function in Flash memory.

#### Silicon Revision Affected:

A0

## 5 μDMA

# 5.1 No interrupt generated with software-triggered DMA transfer using channel 30

#### **Description:**

When performing a software-triggered data transfer using  $\mu$ DMA channel 30, no interrupt is triggered when the transfer completes.

Use any of the other channels (except for channel 30 and 31) that are not already assigned to a peripheral. See the "DMA Channel Assignments" table in the *Micro Direct Memory Access (µDMA)* chapter in the data sheet.

#### Silicon Revision Affected:

A0

Fixed:

This issue is fixed on parts with a date code of 06 (June 2010) or later. To determine the date code of your part, look at the third line in the part markings, at the fourth and fifth characters following the dash (highlighted in red below). The first number after the dash indicates the last decimal digit of the year. The next character indicates the month, in hexadecimal. So, in the below example, the 9B indicates a date code of November 2009.



The table below shows some example date codes:

Date Code	Date
9B	November 2009
9C	December 2009
01	January 2010
02	February 2010
03	March 2010
04	April 2010
05	May 2010
06	June 2010
07	July 2010
08	August 2010
09	September 2010
0A	October 2010
0B	November 2010
OC	December 2010

# 5.2 The µDMA controller fails to generate capture mode DMA requests from Timer A in the Timer modules

#### Description:

The  $\mu$ DMA controller fails to generate DMA requests from Timer A in the General-Purpose Timer modules when in the Event Count and Event Time modes.

Use Timer B.

Silicon Revision Affected:

A0

# 6 GPIO

## 6.1 **GPIO** commit register control not working as expected

#### **Description:**

The commit control registers provide a layer of protection against accidental programming of critical hardware peripherals, especially the JTAG/SWD pin functionality. Writes to protected bits of the GPIO Alternate Function Select (GPIOAFSEL), GPIO Digital Enable (GPIODEN), and GPIO Pull-up Select (GPIOPUR) registers are not committed to storage unless the GPIO Lock (GPIOLOCK) register has been unlocked and the appropriate bits of the GPIO Interrupt Clear (GPIOCR) register have been set. Registers GPIODEN and GPIOPUR should be protected by this mechanism but are not.

#### Workaround:

Extra caution should be taken by software when modifying the **GPIODEN** and **GPIOPUR** registers as they are not protected by the **GPIOCR** commit register mechanism. Writes to the register bits that affect the JTAG/SWD pins (PC0-PC3) should be done with great care as this interface may become permanently disabled if done incorrectly. The NMI pin (PB7) is not protected either.

#### Silicon Revision Affected:

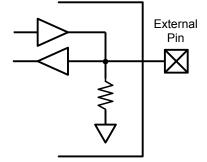
A0

## 6.2 PB0 and PB1 have permanent internal pull-down resistance

#### **Description:**

Regardless of their configuration, PB0 and PB1 have an internal pull-down resistance. The internal structure of these pins is shown in Figure 1 on page 8.

#### Figure 1. Internal Structure of PB0 and PB1



The characteristic of the pull-down for PB0 is shown in Figure 2 on page 9. The data labels for each data point show the external pull-up resistance in Ohms.

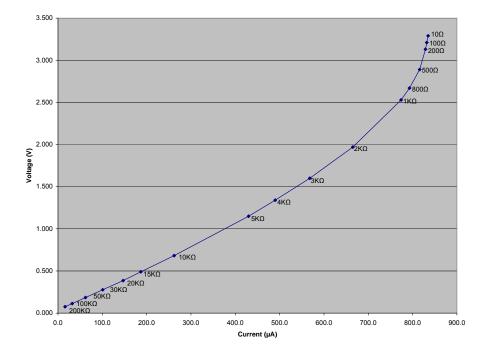


Figure 2. Voltage vs. Current for Various External Pull-up Resistors on PB0

The characteristic of the pull-down for PB1 is shown in Figure 3 on page 10. The data labels for each data point show the equivalent resistance in Ohms.

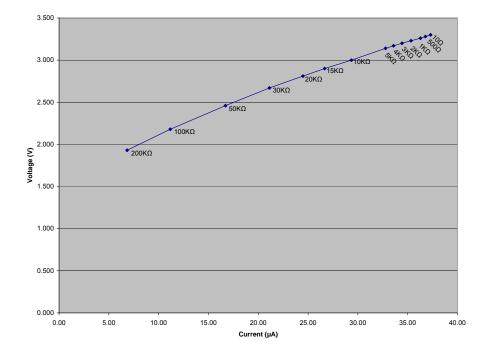


Figure 3. Voltage vs. Current for Various External Pull-up Resistors on PB1

When either of these pins is configured as an input, the external circuit must provide enough drive strength to over-drive the internal pull-down and achieve the necessary V<sub>IH</sub> voltage level. If an external pull-up resistor is used, it must have a low value such as ~1 K $\Omega$  or less for PB0 and ~50 K $\Omega$  or less for PB1.

When either of these pins is configured as an output, the drive current needed to over-drive the internal pull-down resistance must be subtracted from the drive capabilities of the pin. In some applications, it may be necessary to select a higher drive strength (such as 4 mA instead of 2 mA) to achieve an acceptable output voltage on PB0.

#### Silicon Revision Affected:

A0

## 7 General-Purpose Timers

# 7.1 General-purpose timer 16-bit Edge Count or Edge Time mode does not load reload value

#### **Description:**

In Edge Count or Edge Time mode, the input events on the CCP pin decrement the counter until the count matches what is in the **GPTM Timern Match (GPTMTnMATCHR)** register. At that point, an interrupt is asserted and then the counter should be reloaded with the original value and counting begins again. However, the reload value is not reloaded into the timer.

Rewrite the GPTM Timern Interval Load (GPTMTnILR) register before restarting.

Silicon Revision Affected:

A0

# 7.2 The General-Purpose Timer match register does not function correctly in 32-bit mode

#### **Description:**

The **GPTM Timer A Match (GPTMTAMATCHR)** register triggers a match interrupt and a DMA request, if enabled, when the lower 16 bits match, regardless of the value of the upper 16 bits.

#### Workaround:

None.

Silicon Revision Affected:

A0

# 7.3 A spurious DMA request is generated when the timer rolls over in Input-Edge Time mode

#### **Description:**

When the timer is in Input-Edge Time mode and rolls over after the terminal count, a spurious DMA request is generated.

#### Workaround:

Either ignore the spurious interrupt, or disable DMA requests shortly before the terminal count and enable them again shortly after the terminal count.

#### Silicon Revision Affected:

A0

## 8 ADC

# 8.1 Use of "Always" triggering for ADC Sample Sequencer 3 does not work

#### **Description:**

When using ADC Sample Sequencer 3 (SS3) and configuring the trigger source to "Always" to enable continuous sampling by programming the SS3 Trigger Select field (EM3) in the **ADC Event Multiplexer Select (ADCEMUX)** register to 0xF, the first sample will be captured, but no further samples will be updated to the sequencer FIFO. Interrupts are continuously generated after the first sample and the FIFO status remains empty.

#### Workaround:

Software must disable and re-enable the sample sequencer to capture another sample.

Silicon Revision Affected:

A0

# 8.2 Using the PWM unit to trigger the ADC results in only one sample taken

#### **Description:**

If the ADC is configured to trigger from a PWM generator source, the ADC unit is triggered on the first matched event in the **PWMn Interrupt and Trigger Enable (PWMnINTEN)** register; however, it will receive no further triggers at the subsequent event matches.

#### Workaround:

If the raw interrupt status is cleared before the next event match, the ADC correctly receives the next event signal. Therefore, the trigger condition must be cleared using the same interrupt condition in the **PWMn Interrupt Status and Clear (PWMnISC)** register.

Trigger condition	Interrupt status and clear
TrCntZero	IntCntZero
TrCntLoad	IntCntLoad
TrCmpAU	IntCmpAU
TrCmpAD	IntCmpAD
TrCmpBU	IntCmpBU
TrCmpBD	IntCmpBD

For example, consider the scenario where the ADC performs sequence 0 and generates a processor interrupt when triggered by PWM generator 2 CMPAD (comparator A value count down match). The DriverLib call to enable the PWM to trigger the ADC is:

```
PWMGenIntTrigEnable(PWM_BASE, PWM_GEN_2, PWM_TR_CNT_AD);
```

In the ADC sequence 0 interrupt handler, both the ADC interrupt status bit and the PWM generator 2 status bits must be cleared, as follows:

```
void
ADC0IntHandler(void)
{
    // // Clear the PWM trigger source
    // This step is for an errata workaround
    //
    PWMGenIntClear(PWM_BASE, PWM_GEN_2, PWM_INT_CNT_AD);
    //
    // Clear the ADC interrupt status
    //
    ADCIntClear(ADC_BASE, 0);
```

#### ... remaining ADC interrupt handler code...

#### Silicon Revision Affected:

## 8.3 TIMER3 cannot trigger ADC

#### **Description:**

The **ADC Event Multiplexer Select (ADCEMUX)** register can be used to select the event (trigger) that initiates sampling for each sample sequencer. However, Timer 3 cannot be used to trigger analog-to-digital conversions.

#### Workaround:

Use one of the other timers to trigger ADC.

#### Silicon Revision Affected:

A0

# 8.4 Incorrect behavior with timer ADC triggering when another timer is used in 32-bit mode

#### **Description:**

When a timer is configured to trigger the ADC and another timer is configured to be a 32-bit periodic or one-shot timer, the ADC is triggered continuously instead of the specified interval.

#### Workaround:

Do not use a 32-bit periodic or one-shot timer when triggering ADC. If the timer is in 16-bit mode, the ADC trigger works as expected.

#### Silicon Revision Affected:

A0

# 8.5 ADC hardware averaging produces erroneous results in differential mode

#### **Description:**

The implementation of the ADC averaging circuit does not work correctly when the ADC is sampling in differential mode and the difference between the voltages is approximately 0.0V.

#### Workaround:

Do not use hardware averaging in differential mode. Instead, use the FIFO to store results and average them in software.

#### Silicon Revision Affected:

A0

# 8.6 Retriggering a sample sequencer before it has completed the current sequence results in continuous sampling

#### Description:

Re-triggering a sample sequencer before it has completed its programmed conversion sequence causes the sample sequencer to continuously sample. If interrupts have been enabled, interrupts

are generated at the appropriate place in the sample sequence. This problem only occurs when the new trigger is the same type as the current trigger.

#### Workaround:

Ensure that a sample sequence has completed before triggering a new sequence using the same type of trigger.

#### Silicon Revision Affected:

A0

## 8.7 ADC inputs have the incorrect channel assignments

#### **Description:**

Instead of channels 0, 1, 2, and 3 available on pins PE3, PE2, PE1, and PE0 respectively, the available channels are 4, 5, 6 and 7 available on pins PD3, PD2, PD1 and PD0 respectively.

#### Workaround:

Software must utilize the alternate channels when programming the ADC (for example, use ADC4 instead of ADC0). When configuring the **GPIOAMSEL** register, software must enable analog inputs for the alternate pins (for example, PD3 instead of PE3).

#### Silicon Revision Affected:

A0

#### Fixed:

Fixed devices have 8 channels available so that board changes are not required and have date codes of 0x07 or later.

## 9 UART

# 9.1 The RTRIS bit in the UARTRIS register is only set when the interrupt is enabled

#### **Description:**

The RTRIS (UART Receive Time-Out Raw Interrupt Status) bit in the **UART Raw Interrupt Status** (UARTRIS) register should be set when a receive time-out occurs, regardless of the state of the enable RTIM bit in the UART Interrupt Mask (UARTIM) register. However, currently the RTIM bit must be set in order for the RTRIS bit to be set when a receive time-out occurs.

#### Workaround:

For applications that require polled operation, the RTIM bit can be set while the UART interrupt is disabled in the NVIC using the IntDisable(n) function in the StellarisWare Peripheral Driver Library, where n is 21, 22, or 49 depending whether UART0, UART1 or UART2 is used. With this configuration, software can poll the RTRIS bit, but the interrupt is not reported to the NVIC.

#### Silicon Revision Affected:

# 10 I2C

# 10.1 I<sup>2</sup>C Slave Masked Interrupt Status (I2CSMIS) register bits are incorrect

#### **Description:**

The bits within the I<sup>2</sup>C Slave Masked Interrupt Status (I2CSMIS) register do not operate properly. This register should not be used by software.

#### Workaround:

Software should use the I<sup>2</sup>C Slave Raw Interrupt Status (I2CSRIS) register instead.

#### Silicon Revision Affected:

A0

## 11 **PWM**

### **11.1 PWM** generation is incorrect with extreme duty cycles

#### **Description:**

If a PWM generator is configured for Count-Up/Down mode, and the **PWM Load (PWMnLOAD)** register is set to a value N, setting the compare to a value of 1 or N-1 results in steady state signals instead of a PWM signal. For example, if the user configures PWM0 as follows:

- PWMENABLE = 0x00000001
  - PWM0 Enabled
- PWM0CTL = 0x00000007
  - Debug mode enabled
  - Count-Up/Down mode
  - Generator enabled
- PWM0LOAD = 0x00000063
  - Load is 99 (decimal), so in Count-Up/Down mode the counter counts from zero to 99 and back down to zero (200 clocks per period)
- PWM0GENA = 0x000000b0
  - Output High when the counter matches comparator A while counting up
  - Output Low when the counter matches comparator A while counting down
- PWM0DBCTL = 0x00000000
  - Dead-band generator is disabled

If the **PWM0 Compare A (PWM0CMPA)** value is set to 0x00000062 (N-1), PWM0 should output a 2-clock-cycle long High pulse. Instead, the PWM0 output is a constant High value.

If the **PWM0CMPA** value is set to 0x00000001, PWM0 should output a 2-clock-cycle long negative (Low) pulse. Instead, the PWM0 output is a constant Low value.

#### Workaround:

User software must ensure that when using the PWM Count-Up/Down mode, the compare values must never be 1 or the **PWMnLOAD** value minus one (N-1).

#### Silicon Revision Affected:

A0

### **11.2 PWM sync status is not properly cleared**

#### **Description:**

When writing to the **PWM Time Base Sync (PWMSYNC)** register to sync the PWM generators, the sync bits are not automatically cleared by hardware. This condition results in the PWM counters being held and prevents them from outputting a PWM signal. The issue occurs only when the PWM clock divider is enabled in the **Run-Mode Clock Configuration (RCC)** register. When the USEPWMDIV bit is set, any divider (PWMDIV) exhibits the same behavior.

#### Workaround:

A software write to the **PWMSYNC** register to manually clear the sync bits releases the PWM counters and they will generate expected output waveforms.

#### Silicon Revision Affected:

A0

### 11.3 Sync of PWM does not trigger "zero" action

#### **Description:**

If the **PWM Generator Control (PWM0GENA)** register has the ActZero field set to 0x2, then the output is set to 0 when the counter reaches 0, as expected. However, if the counter is cleared by setting the appropriate bit in the **PWM Time Base Sync (PWMSYNC)** register, then the "zero" action is not triggered, and the output is not set to 0.

#### Workaround:

None.

#### Silicon Revision Affected:

A0

### 11.4 **PWM "zero" action occurs when the PWM module is disabled**

**Description:** 

The zero pulse may be asserted when the PWM module is disabled.

Workaround:

None.

#### Silicon Revision Affected:

### 11.5 **PWM fault latch does not operate correctly**

#### **Description:**

If the LATCH bit is set in th **PWMnCTL** register, the PWM fault condition should be latched until the INTFAULTn bit in the **PWMISC** register is cleared. However, the PWM fault signal is not correctly latched and the PWM resumes programmed signalling after the fault condition is removed, regardless of whether the INTFAULTn bit is cleared.

#### Workaround:

Software can effectively address this issue with the addition of a few register writes in the ISR.

- 1. The **PWMnMINFLTPER** register can be used to ensure that the fault is asserted for a long enough period such that the ISR can be called to implement the workaround.
- 2. The PWM output can be disabled manually using the PWMnEN bit in the **PWMENABLE** register.
- 3. Software can perform computations to determine if the PWM can be restarted.
- 4. The INTFAULTE bit in the **PWMISC** is cleared by writing a 1 to it.
- 5. The PWM output can be manually re-enabled using the PWMnEN bit in the **PWMENABLE** register.

Note that when using this workaround, the PWM output is disabled manually, which means it does not go to the "pre-programmed" state from various fault registers but instead goes to 0.

#### Silicon Revision Affected:

A0

## 12 QEI

### 12.1 **QEI** index resets position when index is disabled

#### **Description:**

When the QEI module is configured to not reset the position on detection of the index signal (that is, the ResMode bit in the QEI Control (QEICTL) register is 0), the module resets the position when the index pulse occurs. The position counter should only be reset when it reaches the maximum value set in the QEI Maximum Position (QEIMAXPOS) register.

#### Workaround:

Do not rely on software to disable the index pulse. Do not connect the index pulse if it is not needed.

#### Silicon Revision Affected:

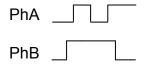
A0

### 12.2 QEI hardware position can be wrong under certain conditions

#### **Description:**

The **QEI Position (QEIPOS)** register can be incorrect if the QEI is configured for quadrature phase mode (SigMode bit in **QEICTL** register = 0) and to update the position counter of every edge of both PhA and PhB (CapMode bit in **QEICTL** register = 1). This error can occur if the encoder is

stepped in the reverse direction, stepped forward once, and then continues in the reverse direction. The following sequence of transitions on the PhA and PhB pins causes the error:



Assuming the starting position prior to the above PhA and PhB sequence is 0, the position after the falling edge on PhB should be -3, however the **QEIPOS** register will show the position to be -1.

#### Workaround:

Configure the QEI to update the position counter on every edge on PhA only (CapMode bit in **QEICTL** register = 0). The effective resolution is reduced by 50%. If full resolution position detection is required by updating the position counter on every edge of both PhA and PhB, no workaround is available. Hardware and software must take this into account.

#### Silicon Revision Affected:

A0

# **13** Electrical Characteristics

### 13.1 Certain pins do not fully comply with the JEDEC ESD standard

#### **Description:**

The pins listed below do not fully meet the industry ESD standard of 2.0 KV Human Body Model (HBM) under all conditions. All Stellaris devices are tested using JEDEC Standard JESD22-A114. These pins fail only in the pin-to-power condition using a positive voltage transient. The pins pass at 500 V. All other HBM conditions pass on these pins. All other device pins fully comply with this HBM JEDEC standard.

- PB0
- PB1
- PF0
- OSC0
- OSC1

#### Workaround:

Extra caution should be taken to ensure proper ESD handling of these devices. Use appropriate caution when implementing ESD protection circuits on signals routed to these pins.

#### Silicon Revision Affected:

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